Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	22	nonocomposite	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 10:32
L2	27	nanoclay near1 particle	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 10:45
L3	78730	platelet tactoid	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 10:11
L4	393	nanoclay	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 10:12
L5	1	1 and 4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 10:13
L6	27	2 and 4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 10:13
L7	11	2 and 3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 10:13
L8	11	7 and polymer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 10:14

L9	5	8 and substrate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 10:14
L10	7	8 and (substrate carrier board)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 10:32
L11	0	1 and 2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 10:19
L12	0	("6890973").URPN.	USPAT	OR	ON	2005/12/05 10:20
L13	1	("6410142").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/12/05 10:21
L14	6	("6228471").URPN.	USPAT	OR	ON	2005/12/05 10:25
L15	3298	nanocomposite	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 10:32
L16	136	15 and 4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 10:32
L17	86	16 and (substrate carrier board)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 10:52
L18	19	17 and (conductive (metal near1 layer))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 10:34

L19	1	18 and sandwich$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 10:34
L20	0	("6593688").URPN.	USPAT	OR	ON	2005/12/05 10:39
L21	8	("4145480" | "5326692" | "5593788" | "5653914" | "5705888" | "5719467" | "6146809" | "6274065").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/12/05 10:39
L22	17	"3258387"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 16:15
L23	0	2003/0030999	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 10:46
L24	2	"20030030999"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 12:34
L25	2	"20040025743"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 13:21
L26	5	"6653388"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 10:46
L27	5	"2005010209"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 10:46

L28	31	22 23 24 25 26 27	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 10:46
L29	5	28 and (nanoparticle nanocomposite nano)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 12:35
L30	1719	15 and (substrate carrier board)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 10:53
L31	740	30 and (conductive conducting conductor)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 10:55
L32	61	31 and (nanoclay ((natural synthetic) near clay))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 16:30
L33	60	32 and polymer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 10:56
L34	58	33 and ratio	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 10:57
L35	0	("6924027").URPN.	USPAT	OR	ON	2005/12/05 11:00
L36	2	("5652290" | "6451422").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/12/05 11:00
L37	145	31 and clay	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 12:15

L38	1	37 and (solder near1 (resist mask))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 12:03
L39	6	31 and (solder near1 (resist mask))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 12:13
L40	0	("6919508").URPN.	USPAT	OR	ON	2005/12/05 12:08
L41	5	("6518090" | "6632028" | "6657124" | "6753208" | "6781244").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/12/05 12:08
L42	195	31 and (resist mask)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 12:14
L43	178	42 and polymer$2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 12:14
L44	50	43 and clay	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 12:15
L45	51	43 and (nanoclay clay)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 12:15
L46	0	24 and (nanoparticle nanocomposite)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 12:35
L47	0	24 and (nanoparticle nano nanocomposite)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 12:35

L48	0	25 and (nano nanoclay)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 13:21
L49	8275	(nanoclay ((natural synthetic) near clay))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 16:31
L50	46	nanoclay and (synthetic near clay)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 16:31
L51	1	nanoclay with (synthetic near clay)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 16:31
L52	7	nanoclay same (synthetic near clay)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/05 16:31